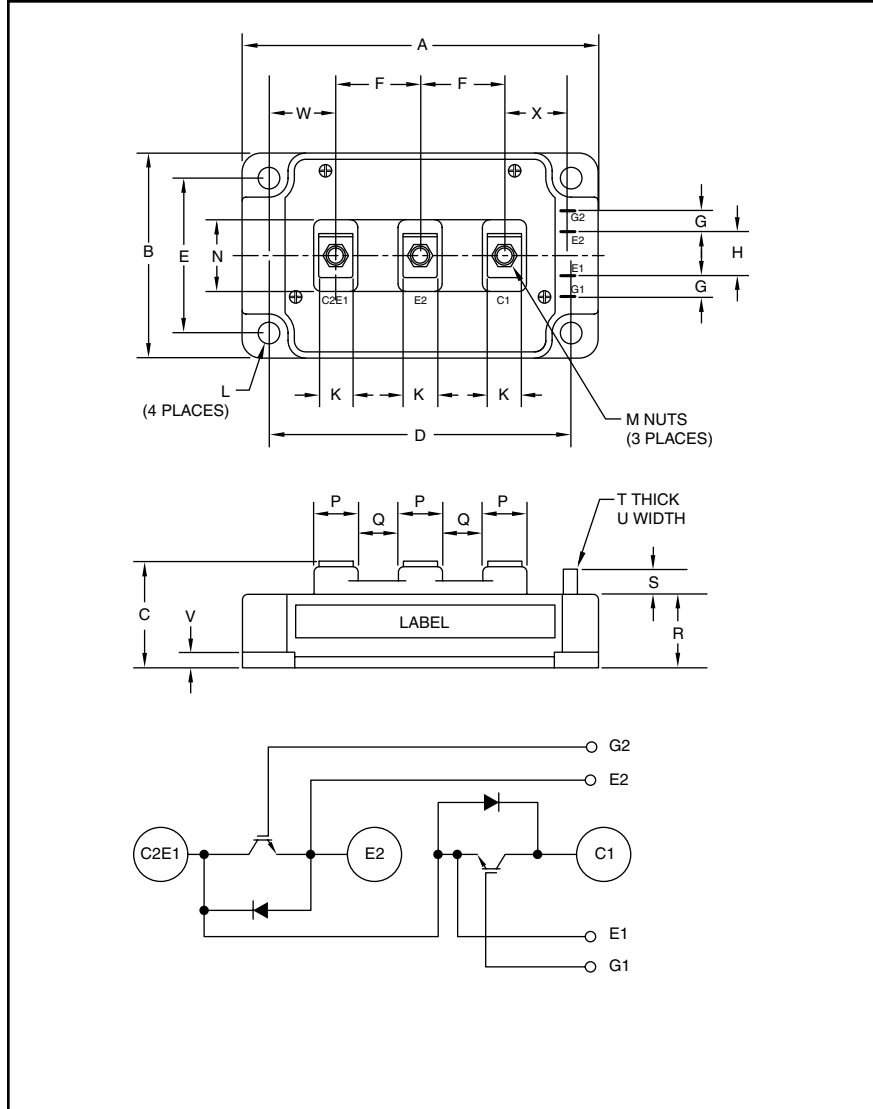


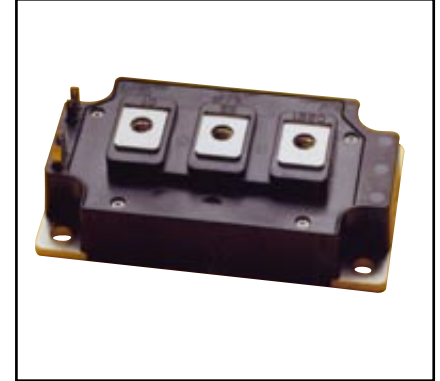
Dual IGBTMOD™ A-Series Module 200 Amperes/1700 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.25	108.0
B	2.44	62.0
C	1.18+0.04/-0.02	30.0+1.0/-0.5
D	3.66±0.01	93.0±0.25
E	1.89±0.01	48.0±0.25
F	0.98	25.0
G	0.24	6.0
H	0.59	15.0
K	0.55	14.0
L	0.26 Dia.	Dia. 6.5
M	M6 Metric	M6

Dimensions	Inches	Millimeters
N	1.18	30.0
P	0.71	18.0
Q	0.28	7.0
R	0.87	22.2
S	0.33	8.5
T	0.02	0.5
U	0.110	2.8
V	0.16	4.0
W	0.85	21.5
X	0.94	24.0



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:

- ☐ AC Motor Control
- ☐ UPS
- ☐ Battery Powered Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM200DY-34A is a 1700V (V_{CES}), 200 Ampere Dual IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	200	34

CM200DY-34A

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Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM200DY-34A	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E Short)	V_{CES}	1700	Volts
Gate-Emitter Voltage (C-E Short)	V_{GES}	± 20	Volts
Collector Current (DC, $T_C = 109^\circ\text{C}^*$)	I_C	200	Amperes
Peak Collector Current	I_{CM}	400**	Amperes
Emitter Current*** ($T_C = 25^\circ\text{C}$)	I_E	200	Amperes
Peak Emitter Current***	I_{EM}	400**	Amperes
Maximum Collector Dissipation ($T_C = 25^\circ\text{C}^*$, $T_j \leq 150^\circ\text{C}$)	P_C	1980	Watts
Mounting Torque, M5 Main Terminal	—	30	in-lb
Mounting Torque, M6 Mounting	—	40	in-lb
Weight	—	400	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{ISO}	3500	Volts

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0\text{V}$	—	—	1.0	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0\text{V}$	—	—	2.0	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 20\text{mA}$, $V_{CE} = 10\text{V}$	5.5	7.0	8.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 200\text{A}$, $V_{GE} = 15\text{V}$, $T_j = 25^\circ\text{C}$	—	2.2	2.8	Volts
		$I_C = 200\text{A}$, $V_{GE} = 15\text{V}$, $T_j = 125^\circ\text{C}$	—	2.45	—	Volts
Total Gate Charge	Q_G	$V_{CC} = 1000\text{V}$, $I_C = 200\text{A}$, $V_{GE} = 15\text{V}$	—	1330	—	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 200\text{A}$, $V_{GE} = 0\text{V}$	—	—	3.0	Volts

Dynamic Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}	$V_{CE} = 10\text{V}$, $V_{GE} = 0\text{V}$	—	—	49.4	nf
Output Capacitance	C_{oes}		—	—	5.6	nf
Reverse Transfer Capacitance	C_{res}		—	—	1.06	nf
Inductive	Turn-on Delay Time	$V_{CC} = 1000\text{V}$, $I_C = 200\text{A}$, $V_{GE1} = V_{GE2} = 15\text{V}$, $R_G = 2.4\Omega$, Inductive Load	—	—	550	ns
Load	Rise Time		—	—	190	ns
Switch	Turn-off Delay Time		—	—	750	ns
Time	Fall Time		—	—	350	ns
Diode Reverse Recovery Time***	t_{rr}	Switching Operation,	—	—	450	ns
Diode Reverse Recovery Charge***	Q_{rr}	$I_E = 200\text{A}$	—	20	—	μC

* T_C , T_f measured point is just under the chips.

**Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.

***Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

CM200DY-34A

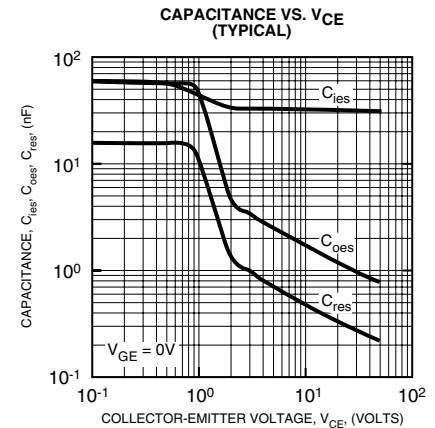
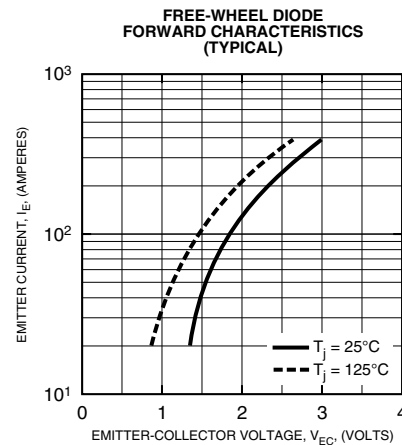
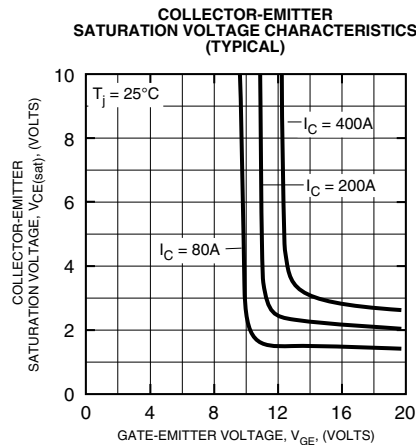
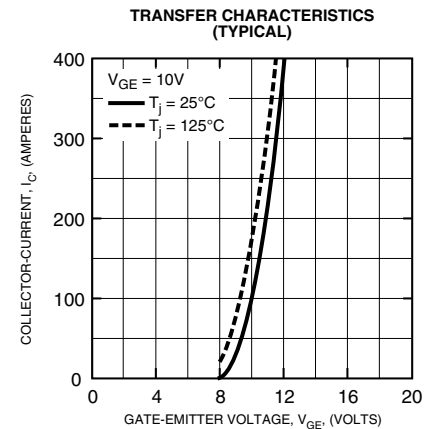
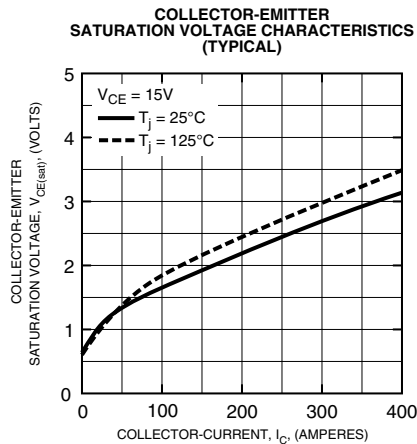
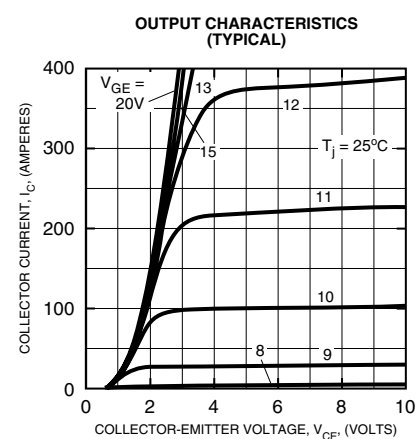
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Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case*	$R_{th(j-c)Q}$	Per IGBT 1/2 Module	—	—	0.063	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case*	$R_{th(j-c)D}$	Per FWDi 1/2 Module	—	—	0.11	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per 1/2 Module, Thermal Grease Applied	—	0.02	—	$^\circ\text{C/W}$
External Gate Resistance	R_G		2.4	—	24	Ω

* T_C , T_f measured point is just under the chips.



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